

Vishay Siliconix

COMPLIANT

### N-Channel 12-V (D-S) MOSFET

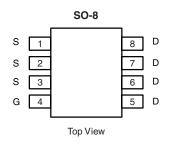
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
	0.0027 at V <sub>GS</sub> = 4.5 V	34			
12	0.0032 at V <sub>GS</sub> = 2.5 V	31	33 nC		
	0.0040 at V <sub>GS</sub> = 1.8 V	28			

#### **FEATURES**

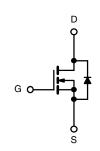
- Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested

#### **APPLICATIONS**

Low V<sub>IN</sub> DC/DC



Ordering Information: Si4838BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	12	V		
Gate-Source Voltage	V <sub>GS</sub>	± 8			
	T <sub>C</sub> = 25 °C		34	1	
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		27		
Continuous Drain Current $(1) = 150^{\circ}$ C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	22.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		18.0 <sup>b, c</sup>		
Pulsed Drain Current	I <sub>DM</sub>	70	— A		
Continuous Course Drain Diada Current	T <sub>C</sub> = 25 °C	la.	5.1		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.2 <sup>b, c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	20		
Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		5.7	w	
Maximum Power Dissinction	T <sub>C</sub> = 70 °C	P <sub>D</sub>	3.6		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	'D	2.50 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature R	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b,d</sup>	$t \le 10 s$	R <sub>thJA</sub>	39	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	18	22	0/11		

Notes:

a. Based on T<sub>C</sub> = 25 °C. b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 °C/W.



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<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	1			1	1		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	12			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	l <sub>D</sub> = 250 μA		12		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	10 - 200 μ.τ		- 3.2			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.4		1.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V$ , $V_{GS} = \pm 8 V$			± 100	nA	
Zara Cata Valtaga Dusia Quanat	I <sub>DSS</sub>	V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current		$V_{DS} = 12$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5$ V, $V_{GS} = 4.5$ V	30			А	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		0.0021	0.0027	2 Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 12 \text{ A}$		0.0025	0.0032		
		V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 10 A		0.0031	0.0040		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		105		S	
Dynamic <sup>b</sup>					1	I	
Input Capacitance	C <sub>iss</sub>			5760			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1730		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			1145			
		$V_{DS} = 6 V, V_{GS} = 4.5 V, I_{D} = 10 A$		56	84		
Total Gate Charge	Qg			33	50	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 10 A		5.9			
Gate-Drain Charge	Q <sub>gd</sub>			12.5			
Gate Resistance	Rg	f = 1 MHz	0.2	0.65	1.3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			25	50		
Rise Time	t <sub>r</sub>	$V_{DD} = 6 V, R_1 = 0.6 \Omega$		29	55		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_q = 1 \Omega$		140	240		
Fall Time	t <sub>f</sub>	g		35	65		
Turn-On Delay Time	t <sub>d(on)</sub>			12	24	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 6 V, R_1 = 0.6 \Omega$		13	26	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 8 \text{ V}, \text{ R}_a = 1 \Omega$		56	100		
Fall Time	t <sub>f</sub>	B GEN g		10	20		
Drain-Source Body Diode Characteristi				10	20		
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			5.1		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	<u> </u>			70	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A		0.60	1.1	v	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	.5 0		52	1.1	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	4 F		40	80	nC	
		$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$			00		
Reverse Recovery Fall Time	t <sub>a</sub>	4		21		ns	
Reverse Recovery Rise Time lotes:	t <sub>b</sub>			31			

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

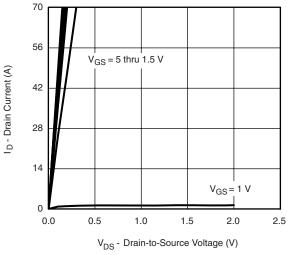
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



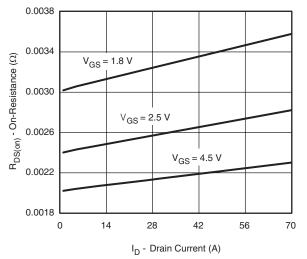
**Si4838BDY** 

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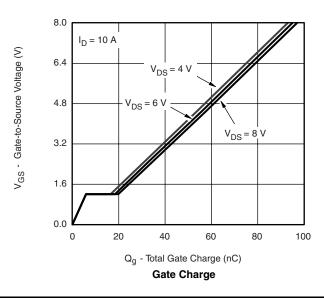
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

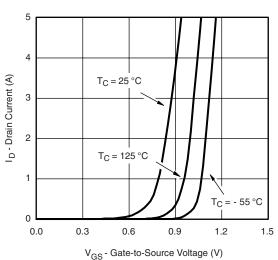




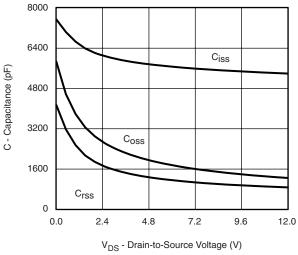


**On-Resistance vs. Drain Current and Gate Voltage** 

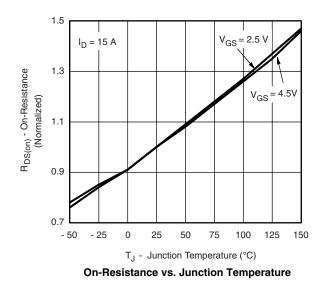




**Transfer Characteristics** 



Capacitance

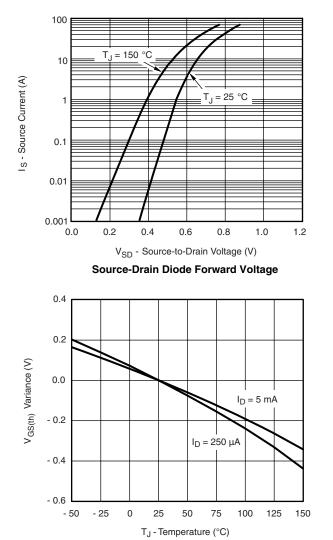


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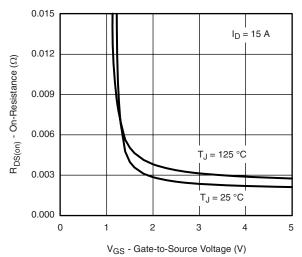


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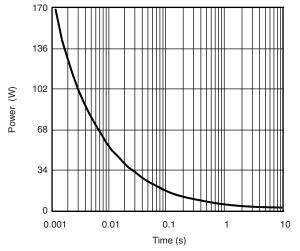
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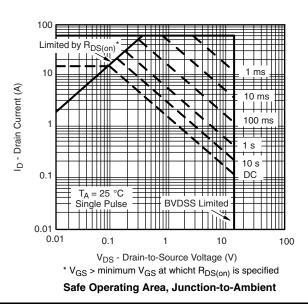
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



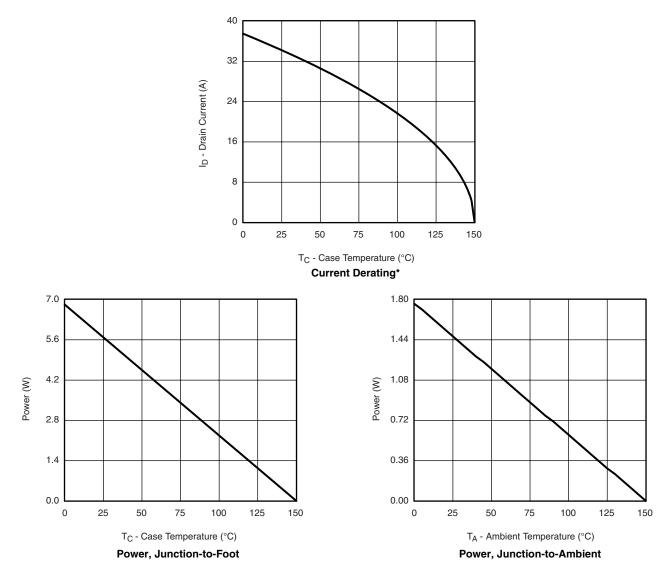






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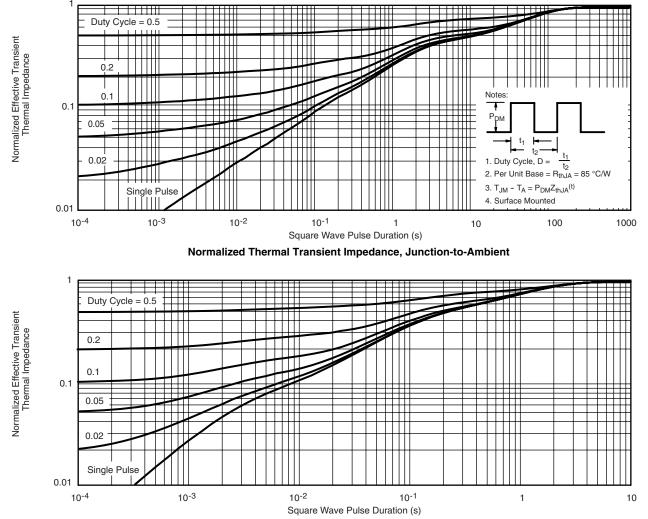


\*The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?68964.



# Package Information

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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES		
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

### **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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